

## 1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT78 plastic package intended for use in applications requiring good bidirectional blocking voltage capability and high thermal cycling performance.

## 2. Features and benefits

- Good bidirectional blocking voltage capability
- High thermal cycling performance

## 3. Applications

- Ignition circuits
- Motor control
- Protection circuits
- Voltage regulation

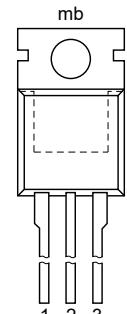
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	-	800	V
$V_{RRM}$	repetitive peak reverse voltage		-	-	800	V
$I_{TSM}$	non-repetitive peak on-state current	half sine wave; $T_{j(init)} = 25^\circ\text{C}$ ; $t_p = 10 \text{ ms}$ ; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a>	-	-	100	A
		half sine wave; $T_{j(init)} = 25^\circ\text{C}$ ; $t_p = 8.3 \text{ ms}$	-	-	110	A
$T_j$	junction temperature		-	-	125	°C
$I_{T(AV)}$	average on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$ ; <a href="#">Fig. 1</a>	-	-	7.5	A
$I_{T(RMS)}$	RMS on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$ ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>	-	-	12	A
<b>Static characteristics</b>						
$I_{GT}$	gate trigger current	$V_D = 12 \text{ V}$ ; $I_T = 0.1 \text{ A}$ ; $T_j = 25^\circ\text{C}$ ; <a href="#">Fig. 7</a>	-	2	15	mA
<b>Dynamic characteristics</b>						
$dV_D/dt$	rate of rise of off-state voltage	$V_{DM} = 335 \text{ V}$ ; $T_j = 125^\circ\text{C}$ ; $R_{GK} = 100 \Omega$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; <a href="#">Fig. 12</a>	200	1000	-	V/μs

## 5. Pinning information

**Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		
3	G	gate		
mb	A	mounting base; connected to anode	 <b>TO-220AB (SOT78)</b>	

## 6. Ordering information

**Table 3. Ordering information**

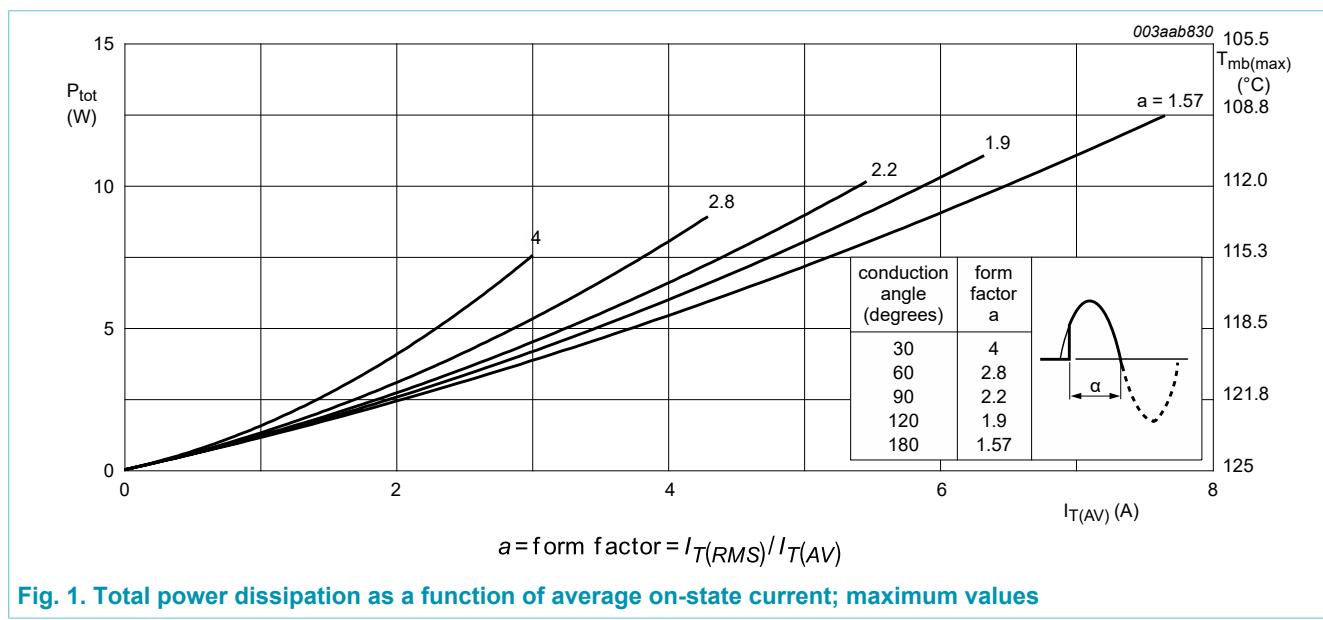
Type number	Package			Version
	Name	Description		
BT151-800C	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB		SOT78

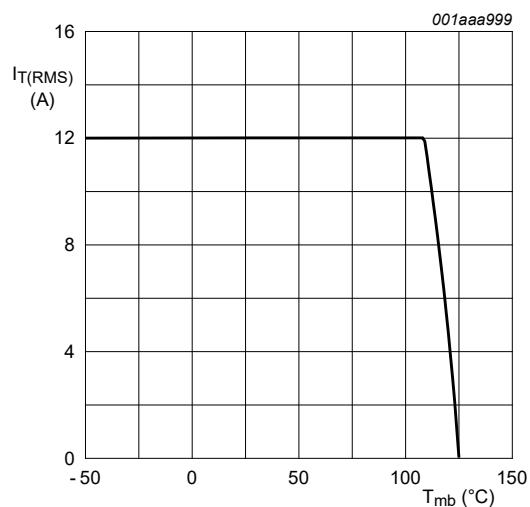
## 7. Limiting values

**Table 4. Limiting values**

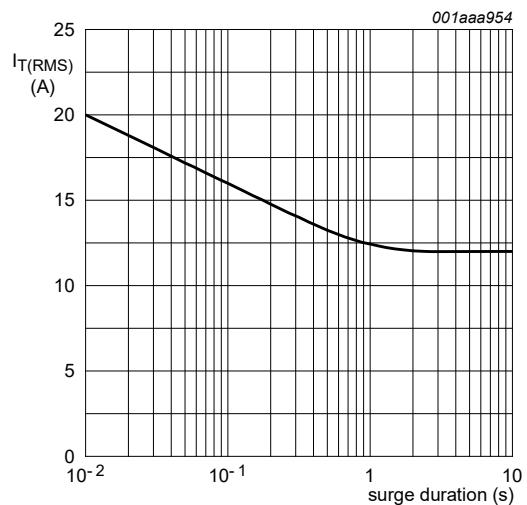
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	800	V
$V_{RRM}$	repetitive peak reverse voltage		-	800	V
$I_{T(AV)}$	average on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$ ; <a href="#">Fig. 1</a>	-	7.5	A
$I_{T(RMS)}$	RMS on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$ ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>	-	12	A
	non-repetitive peak on-state current	half sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$ ; $t_p = 10\text{ ms}$ ; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a>	-	100	A
$I^2t$	$I^2t$ for fusing	$t_p = 10\text{ ms}$ ; SIN	-	50	$\text{A}^2\text{s}$
			-	50	$\text{A}/\mu\text{s}$
$I_{GM}$	peak gate current		-	2	A
$V_{RGM}$	peak reverse gate voltage		-	5	V
$P_{GM}$	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
$T_{stg}$	storage temperature		-40	150	$^\circ\text{C}$
$T_j$	junction temperature		-	125	$^\circ\text{C}$



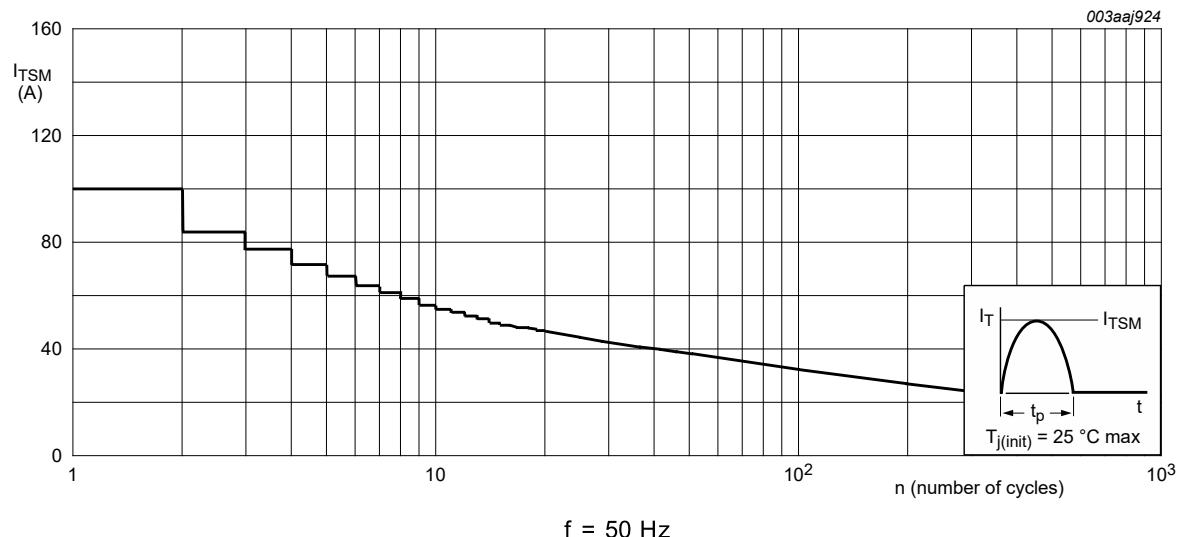


**Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values**



$f = 50 \text{ Hz}; T_{mb} = 109^\circ\text{C}$

**Fig. 3. RMS on-state current as a function of surge duration; maximum values**



**Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values**

## 9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
<b>Static characteristics</b>							
$I_{GT}$	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25^\circ\text{C}$ ; Fig. 7		-	2	15	mA
$I_L$	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25^\circ\text{C}$ ; Fig. 8		-	10	40	mA
$I_H$	holding current	$V_D = 12 \text{ V}; T_j = 25^\circ\text{C}$ ; Fig. 9		-	7	20	mA
$V_T$	on-state voltage	$I_T = 23 \text{ A}; T_j = 25^\circ\text{C}$ ; Fig. 10		-	1.44	1.75	V
$V_{GT}$	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25^\circ\text{C}$ ; Fig. 11		-	0.6	1.5	V
		$V_D = 500 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125^\circ\text{C}$ ; Fig. 11		0.25	0.4	-	V
$I_D$	off-state current	$V_D = 500 \text{ V}; T_j = 125^\circ\text{C}$		-	0.1	0.5	mA
$I_R$	reverse current	$V_R = 500 \text{ V}; T_j = 125^\circ\text{C}$		-	0.1	0.5	mA
<b>Dynamic characteristics</b>							
$dV_D/dt$	rate of rise of off-state voltage	$V_{DM} = 335 \text{ V}; T_j = 125^\circ\text{C}; R_{GK} = 100 \Omega$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; Fig. 12		200	1000	-	V/ $\mu$ s
		$V_{DM} = 335 \text{ V}; T_j = 125^\circ\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; gate open circuit; Fig. 12		50	130	-	V/ $\mu$ s
$t_{gt}$	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = 500 \text{ V}; I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25^\circ\text{C}$		-	2	-	$\mu$ s
$t_q$	commutated turn-off time	$V_{DM} = 335 \text{ V}; T_j = 125^\circ\text{C}; I_{TM} = 20 \text{ A}; V_R = 25 \text{ V}; (dI_T/dt)_M = 30 \text{ A}/\mu\text{s}; dV_D/dt = 50 \text{ V}/\mu\text{s}; R_{GK(ext)} = 100 \Omega$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ )		-	70	-	$\mu$ s

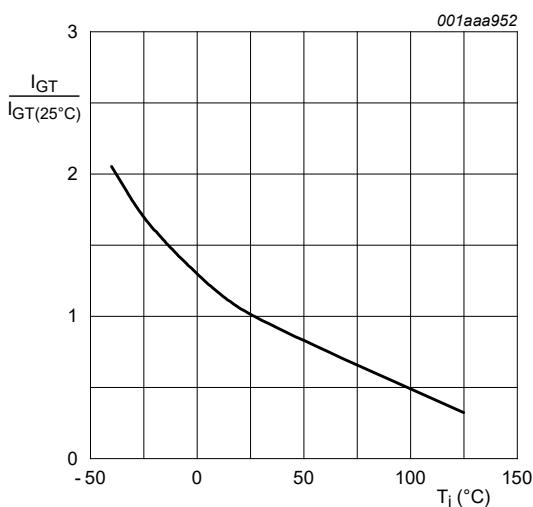


Fig. 7. Normalized gate trigger current as a function of junction temperature

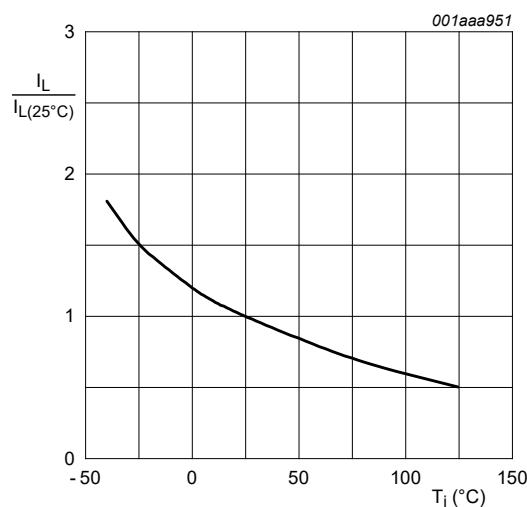


Fig. 8. Normalized latching current as a function of junction temperature

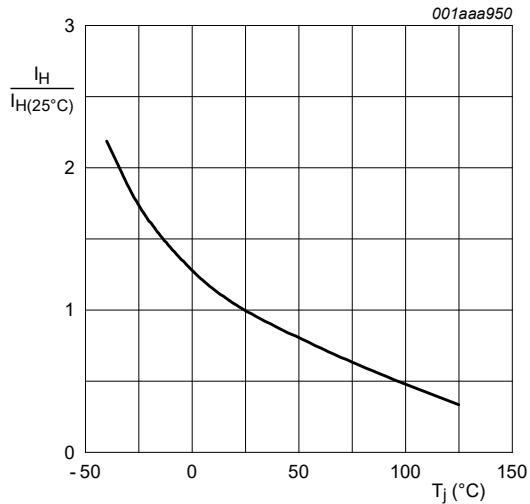
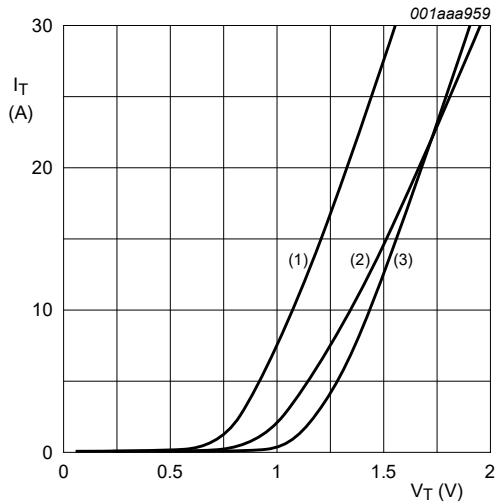


Fig. 9. Normalized holding current as a function of junction temperature



$V_O = 1.06 \text{ V}$ ;  $R_s = 0.0304 \Omega$   
 (1)  $T_j = 125 \text{ }^\circ\text{C}$ ; typical values  
 (2)  $T_j = 125 \text{ }^\circ\text{C}$ ; maximum values  
 (3)  $T_j = 25 \text{ }^\circ\text{C}$ ; maximum values

Fig. 10. On-state current as a function of on-state voltage

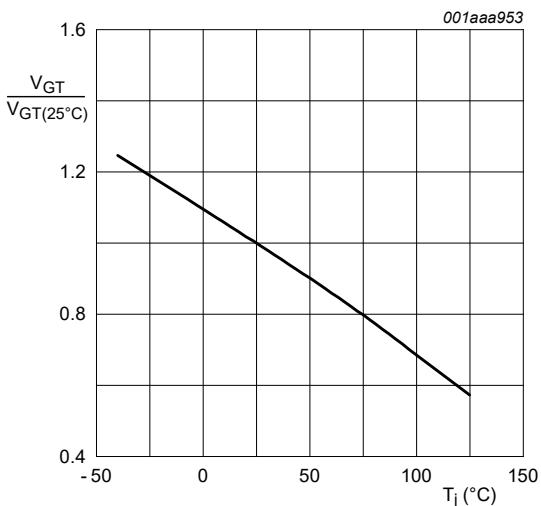


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

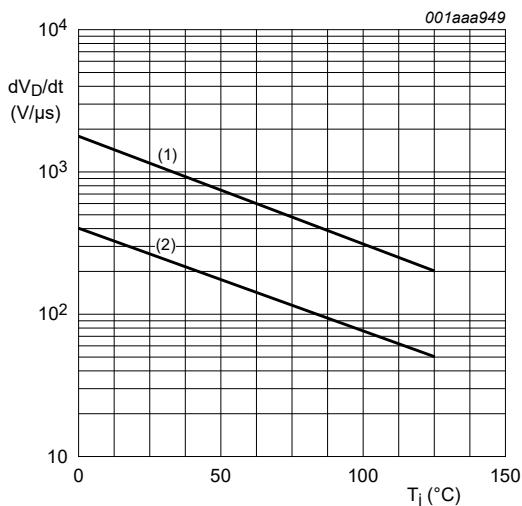
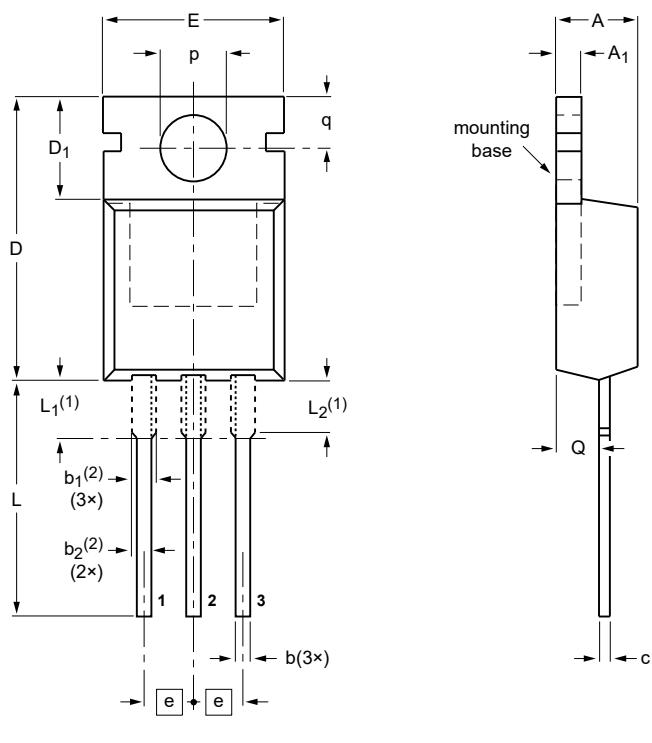


Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; minimum values

## 10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



0 5 10 mm  
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	b	b <sub>1(2)</sub>	b <sub>2(2)</sub>	c	D	D <sub>1</sub>	E	e	L	L <sub>1(1)</sub>	L <sub>2(1)</sub> max.	p	q	Q
mm	4.7	1.40	0.9	1.6	1.3	0.7	16.0	6.6	10.3	2.54	15.0	3.30	3.0	3.8	3.0	2.6
	4.1	1.25	0.6	1.0	1.0	0.4	15.2	5.9	9.7		12.8	2.79	3.0	3.5	2.7	2.2

### Notes

1. Lead shoulder designs may vary.
2. Dimension includes excess dambar.

### IMPORTANT NOTICE – PLEASE READ CAREFULLY

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